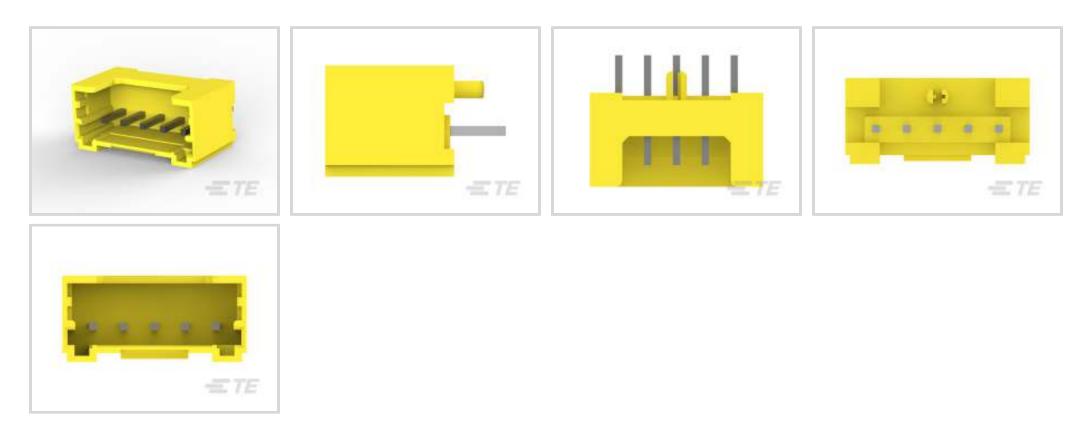


#### **GRACE INERTIA 2.0**

TE Internal #: 3-1971032-5 PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0

#### View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 5

Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in ]

PCB Mount Orientation: Vertical

## Features

Connectivity

#### Product Type Features

Connector System	Wire-to-Board	
Header Type	Fully Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Number of Positions	5	
Number of Rows	1	
PCB Mount Orientation	Vertical	
Electrical Characteristics		
Operating Voltage	50 VAC	
Body Features		
Primary Product Color	Yellow	

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0



#### **Contact Features**

Mating Square Post Dimension	.5 mm[.02 in]	
PCB Contact Termination Area Plating Material Thickness	2 µm[78.73 µin]	
Contact Layout	Inline	
Contact Underplating Material Thickness	1 μm[39.37 μin]	
Contact Mating Area Plating Material Thickness	2 μm[78.74 μin]	
PCB Contact Termination Area Plating Material Finish	Bright	
Contact Mating Area Plating Material Finish	Bright	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Brass	
Contact Mating Area Plating Material	Tin	
Contact Type	Tab	
Contact Current Rating (Max)	2.2 A	
Termination Features		
Square Termination Post & Tail Dimension	.5 mm[.02 in]	
Termination Post & Tail Length	2.6 mm[.102 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	

## Mechanical Attachment

PCB Mount Alignment Type	Locating Posts
Mating Alignment Type	Keyed
Mating Retention	With
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	With
PCB Mount Retention	Without
Housing Features	
Housing Material	Nylon 66 GF
	Nylon 66 GF 2 mm[.079 in]
Housing Material	
Housing Material Centerline (Pitch)	
Housing Material Centerline (Pitch) <b>Dimensions</b>	2 mm[.079 in]

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0



Connector Width	5.6 mm[.22 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Operating Temperature Range	-30 - 105 °C[-22 - 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Agency/Standard	UL
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	300
Packaging Type	Package
Product Compliance	
For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 260°C

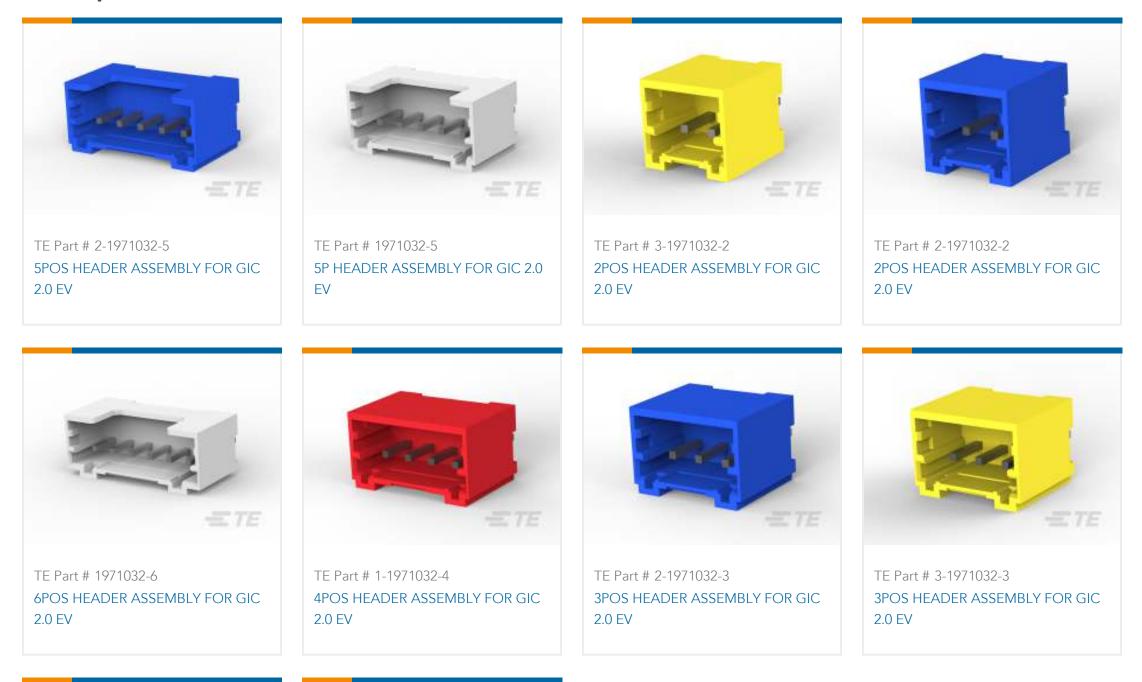
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0



# **Compatible Parts**





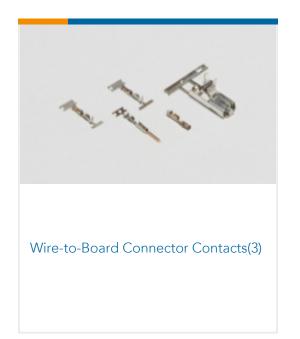
TE Fall # 1-197 1032-3	TE Fall # Z-197 103Z-4
5POS HEADER ASSEMBLY FOR GIC	4POS HEADER ASSMBLY FOR GIC 2.0
2.0 EV	EV

# Also in the Series GRACE INERTIA 2.0

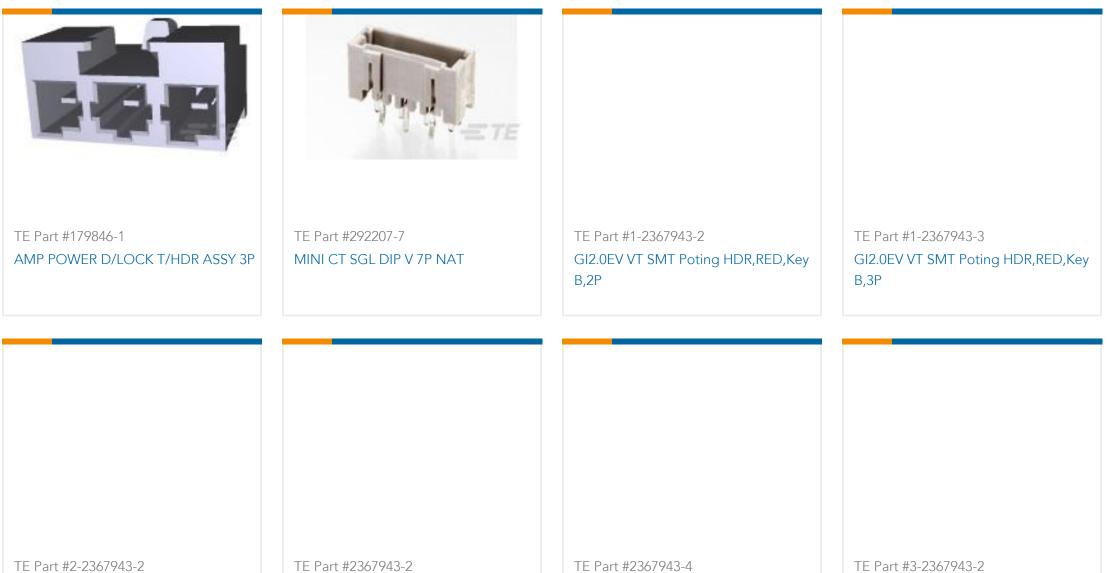


PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0





# Customers Also Bought



TE Part #2-2367943-2 GI2.0EV VT SMT Poting HDR,BLU,Key C,2P	TE Part #2367943-2 GI2.0EV VT SMT Poting HDR,NTL,Key A,2P	TE Part #2367943-4 GI2.0EV VT SMT Poting HDR,NTL,Key A,4P	TE Part #3-2367943-2 GI2.0EV VT SMT Poting HDR,YLW,Key D,2P
TE Part #4-2367943-5 GI2.0EV VT SMT Poting HDR,BLK,Key E,5P			
Documents			

#### Documents

**Product Drawings** 5POS HEADER ASSEMBLY FOR GIC 2.0 EV

English

5POS HEADER ASSEMBLY FOR GIC 2.0 EV

English

#### **CAD** Files

3D PDF

3D

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0



Customer View Model

ENG\_CVM\_CVM\_3-1971032-5\_D.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_3-1971032-5\_D.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_3-1971032-5\_D.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Product Environmental Compliance Product Compliance

English

**Product Compliance** 

English